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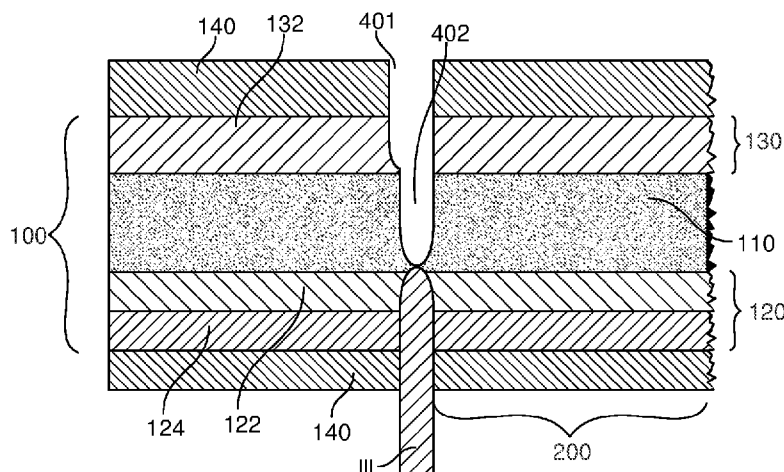


FIG. 4

(57) Abstract: A method of manufacturing an optical element includes forming a first optical layer assembly over a first surface of a planar glass substrate, forming a second optical layer assembly over a second surface of the planar glass substrate, laser cutting entirely through the first optical layer assembly from a first side of the planar glass substrate to form an optical element pattern in the first optical layer assembly, laser cutting entirely through the planar glass substrate from the first side of the planar glass substrate to form the optical element pattern in the planar glass substrate, and laser cutting entirely through the second optical layer assembly from a second side of the planar glass substrate to form the optical element having the optical element pattern.



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## 1 GLASS-FILM LAMINATION AND CUTTING METHOD TO MITIGATE ORANGE PEEL

## 2 TECHNICAL FIELD

3 [0001] The present disclosure is generally directed to the formation of optical elements, and  
4 more particularly to lamination and cutting methods for forming substantially defect-free  
5 polarizing thin films.

## 6 BACKGROUND

7 [0002] Polymer and other organic materials may be incorporated into a variety of different  
8 optic and electro-optic device architectures, including passive and active optics and  
9 electroactive devices. Lightweight and conformable, one or more polymer/organic solid  
10 layers may be incorporated into wearable devices such as smart glasses and are attractive  
11 candidates for emerging technologies including virtual reality/augmented reality devices  
12 where a comfortable, adjustable form factor is desired.

13 [0003] Virtual reality (VR) and augmented reality (AR) eyewear devices or headsets, for  
14 instance, may enable users to experience events, such as interactions with people in a  
15 computer-generated simulation of a three-dimensional world or viewing data superimposed  
16 on a real-world view. By way of example, superimposing information onto a field of view may  
17 be achieved through an optical head-mounted display (OHMD) or by using  
18 embedded wireless glasses with a transparent heads-up display (HUD) or augmented  
19 reality (AR) overlay. VR/AR eyewear devices and headsets may be used for a variety of  
20 purposes. For example, governments may use such devices for military training, medical  
21 professionals may use such devices to simulate surgery, and engineers may use such devices  
22 as design visualization aids.

23 [0004] For use in various optical systems, lenses and other optical devices may be co-  
24 integrated with one or more optically active polymer/organic layers that are configured to  
25 manipulate light that is incident upon the device. One or more optically active  
26 polymer/organic-containing layers may be laminated to a surface of a lens, for example, using  
27 a suitable adhesive. Example optically active layers may include diffraction gratings and  
28 optical filters such as polarizing thin films (e.g., linear polarizers, circular polarizers, reflective  
29 polarizers, transmissive polarizers, quarter waveplates, half waveplates, and the like). Herein,  
30 the terms "optically active layer" and "optical layer" may be used interchangeably and relate  
31 generally to one or more layers configured to modify a characteristic of light, such as its

1 polarization.

2 **[0005]** The act of lamination, particularly over a curved surface of a lens, may introduce  
3 defects in the applied polymer/organic-containing layer(s). Unwanted defects may include  
4 pin holes, ripples, surface roughness, and other localized distortions/surface phenomena such  
5 as orange peel effects. Notwithstanding recent developments, it would be advantageous to  
6 provide a method of forming optical elements, as well as optical devices co-integrated with  
7 such optical elements that are free or substantially free of these and other defects.

8 **SUMMARY**

9 **[0006]** According to a first aspect, there is provided a method comprising: forming a first  
10 optical layer assembly over a first surface of a planar glass substrate; forming a second optical  
11 layer assembly over a second surface of the planar glass substrate; laser cutting entirely  
12 through the first optical layer assembly from a first side of the planar glass substrate to form  
13 an optical element pattern in the first optical layer assembly; laser cutting entirely through  
14 the planar glass substrate from the first side of the planar glass substrate to form the optical  
15 element pattern in the planar glass substrate; and laser cutting entirely through the second  
16 optical layer assembly from a second side of the planar glass substrate to form an optical  
17 element having the optical element pattern.

18 **[0007]** The planar glass substrate may be optically transparent.

19 **[0008]** The first optical layer assembly may comprise one or more optical layers selected from  
20 the group consisting of a linear polarizer, a circular polarizer, a reflective polarizer, a  
21 transmissive polarizer, a quarter waveplate, and a half waveplate.

22 **[0009]** The second optical layer assembly may comprise one or more optical layers selected  
23 from the group consisting of a linear polarizer, a circular polarizer, a reflective polarizer, a  
24 transmissive polarizer, a quarter waveplate, and a half waveplate.

25 **[0010]** The first optical layer assembly may comprise a linear polarizer and a quarter  
26 waveplate, and the second optical layer assembly may comprise a reflective polarizer.

27 **[0011]** Forming the first optical layer assembly may comprise laminating one or more first  
28 optical layers over the first surface of the planar glass substrate, and forming the second  
29 optical layer assembly may comprise laminating one or more second optical layers over the  
30 second surface of the planar glass substrate.

31 **[0012]** The method may further comprise forming a first protective thin film over the first  
32 optical layer assembly prior to laser cutting the first optical layer assembly, and forming a

1 second protective thin film over the second optical layer assembly prior to laser cutting the  
2 second optical layer assembly.

3 **[0013]** Laser cutting the first optical layer assembly may comprise first laser parameters, laser  
4 cutting the second optical layer assembly may comprise second laser parameters, and laser  
5 cutting the planar glass substrate may comprise laser parameters different than the first and  
6 second laser parameters.

7 **[0014]** A laser power for laser cutting the planar glass substrate may be greater than a laser  
8 power for laser cutting either the first optical layer assembly or the second optical layer  
9 assembly.

10 **[0015]** Forming the first optical layer assembly over the first surface of the planar glass  
11 substrate and forming the second optical layer assembly over the second surface of the planar  
12 glass substrate may create a laminate sheet. A plurality of optical elements having the optical  
13 element pattern may be cut from the laminate sheet.

14 **[0016]** The method may further comprise forming the optical element over a planar surface  
15 of a lens having the optical element pattern.

16 **[0017]** The method may further comprise forming the optical element over a planar surface  
17 of a lens. The optical element may comprise, from top to bottom or from one side to another  
18 side, a reflective polarizer, the planar glass substrate, a linear polarizer, and a quarter  
19 waveplate, wherein the quarter waveplate is located adjacent to the planar surface of the  
20 lens.

21 **[0018]** According to a second aspect, there is provided a method comprising: forming an  
22 optical element pattern in a first optical layer assembly disposed over a first surface of a  
23 planar glass substrate by laser cutting entirely through the first optical layer assembly from a  
24 first side of the planar glass substrate; forming the optical element pattern in the planar glass  
25 substrate by laser cutting entirely through the planar glass substrate from the first side of the  
26 planar glass substrate; and forming an optical element having the optical element pattern by  
27 laser cutting entirely through a second optical layer assembly from a second side of the planar  
28 glass substrate, the second optical layer assembly disposed over a second surface of the  
29 planar glass substrate.

30 **[0019]** The planar glass substrate may be optically transparent.

31 **[0020]** The first optical layer assembly may comprise one or more optical layers selected from  
32 the group consisting of a linear polarizer, a circular polarizer, a reflective polarizer, a

1 transmissive polarizer, a quarter waveplate, and a half waveplate.

2 **[0021]** The second optical layer assembly may comprise one or more optical layers selected  
3 from the group consisting of a linear polarizer, a circular polarizer, a reflective polarizer, a  
4 transmissive polarizer, a quarter waveplate, and a half waveplate.

5 **[0022]** The first optical layer assembly may comprise a linear polarizer and a quarter  
6 waveplate, and the second optical layer assembly may comprise a reflective polarizer.

7 **[0023]** A laser power for laser cutting the planar glass substrate may be different than a laser  
8 power for laser cutting either the first optical layer assembly or the second optical layer  
9 assembly.

10 **[0024]** According to a third aspect, there is provided a method comprising: laminating a first  
11 optical layer assembly over a first surface of a transparent planar glass substrate; laminating  
12 a second optical layer assembly over a second surface of the transparent planar glass  
13 substrate; laser cutting through the first optical layer assembly from a first side of the  
14 transparent planar glass substrate to form an optical element pattern in the first optical layer  
15 assembly; laser cutting through the transparent planar glass substrate from the first side of  
16 the transparent planar glass substrate to form the optical element pattern in the transparent  
17 planar glass substrate; and laser cutting through the second optical layer assembly from a  
18 second side of the transparent planar glass substrate to form an optical element having the  
19 optical element pattern.

20 **[0025]** The method may further comprise forming a first protective thin film over the first  
21 optical layer assembly prior to laser cutting the first optical layer assembly, and forming a  
22 second protective thin film over the second optical layer assembly prior to laser cutting the  
23 second optical layer assembly.

24 **[0026]** The presently defined method includes forming a first optical layer assembly over a  
25 first surface of a planar glass substrate and forming a second optical layer assembly over a  
26 second surface of the planar glass substrate to form a laminate sheet. The independent acts  
27 of forming the first and second optical layer assemblies may include orienting and laminating  
28 respective optical layers within each assembly of optical layers. The formation of the first and  
29 second optical layers over a planar glass substrate may significantly inhibit the generation of  
30 orange peel or other surface phenomena during lamination.

31 **[0027]** As used herein, "lamination" may, in some examples, refer to a process through which  
32 two or more layers (e.g., optical layers) are brought together and attached using an

1 intervening layer of adhesive. In a lamination step, the adhesive may be applied to an optical  
2 layer to form an application layer, and the application layer may be contacted with a glass  
3 substrate, lens, or another optical layer to form the laminate. An adhesive may include a layer  
4 of optical adhesive tape or a pressure sensitive adhesive, for example. In some examples, the  
5 adhesive may be cured to form an adhesive layer between the adjacent layers.

6 **[0028]** After the lamination process, the optical element may be visually inspected, for  
7 example, for bubbles, scratches, or other defects. In some examples, a method may be  
8 partially or fully automated. For instance, a lamination process may be performed under  
9 computer control.

10 **[0029]** Plural laser cutting steps are used to separately cut the glass substrate and the first  
11 and second optical layer assemblies according to a pre-selected shape. That is, a first laser  
12 cutting step is used to cut entirely through the first optical layer assembly from a first side of  
13 the planar glass substrate to form an optical element pattern in the first optical layer  
14 assembly. A second laser cutting step is used to cut entirely through the planar glass substrate  
15 from the first side of the planar glass substrate to form the optical element pattern in the  
16 planar glass substrate. A third laser cutting step is used to cut entirely through the second  
17 optical layer assembly from a second side of the planar glass substrate to form an optical  
18 element having the optical element pattern. A pattern recognition paradigm may be used to  
19 align the first side cut shape with the second side cut shape.

20 **[0030]** By separately targeting and successively cutting the first optical layer assembly, the  
21 glass substrate, and the second optical layer assembly, laser cutting parameters may be  
22 independently set for each material layer being cut, which may mitigate damage to non-  
23 targeted layers during the cutting process. For example, a laser power used to cut softer  
24 polymer/organic optical layers may be less than a laser power used to cut a harder glass  
25 substrate. For a given layer, a cutting rate, cut profile, and the propensity of laser-induced  
26 damage may be individually controlled. The avoidance of damage to one or more optical  
27 layers and/or the glass substrate may result in improved pattern fidelity, greater throughput,  
28 and enhanced performance.

29 **[0031]** A picosecond or femto second green laser, for instance, may be used to cut each  
30 respective layer in a glass-film laminate to form an optical element having a desired form  
31 factor. Laser cutting parameters may be chosen to effectively cut each successive layer  
32 without creating damage in the target layer or any layers adjacent to the target layer. The

1 laser cutting process may separate an optical element from a glass-film laminate in a  
2 controllable fashion with negligible debris, minimal induced defects, and low subsurface  
3 damage, preserving strength and geometric fidelity. A laser cutting method may be tuned and  
4 configured to enable manual or mechanical separation, i.e., partial separation or complete  
5 separation of an optical element from the laminate sheet.

6 **[0032]** According to further embodiments, an optical element may be laminated to a planar  
7 surface of a lens to form an optical device. That is, an optical element having an optical  
8 element pattern may be laminated to a planar surface of a lens having the equivalent or  
9 substantially equivalent optical element pattern to form the optical device.

10 **[0033]** As disclosed herein, a glass-film laminate may be formed from a plurality of optically  
11 active layers that are located over opposing sides of a flat glass substrate. Example optically  
12 active layers include diffraction gratings and optical filters such as polarizing thin films (e.g.,  
13 linear polarizers, circular polarizers, reflective polarizers, transmissive polarizers, quarter  
14 waveplates, half waveplates, and the like). The formation of one or more optically active  
15 layers over a flat substrate may decrease the propensity for wrinkling or the generation of  
16 uneven, rough irregularities (i.e., orange peel) in one or more surfaces of the glass-film  
17 laminate. A multitude of optical elements may be harvested from the glass-film laminate  
18 using a sequence of laser cutting steps that independently and successively cut through the  
19 optically active layers and the glass substrate.

20 **[0034]** According to particular embodiments, a first laser cutting step may be used to cut one  
21 or more optically active layers located on one side of the glass substrate and a second laser  
22 cutting step may be used to cut the glass substrate. The partially cut glass-film laminate may  
23 be flipped over and a third laser cutting step may be used to cut one or more optically active  
24 layers located on the other side of the glass substrate. A pattern recognition scheme may be  
25 used to align the front and back-side cutting to produce a desired form factor and avoid laser-  
26 induced damage to one or more of the optically active layers. The alignment accuracy of one  
27 or more polarization layers within each optical element may be improved by harvesting  
28 multiple pre-aligned optical elements from a single glass-film laminate. An optical element  
29 may be sized and dimensioned to overlie a planar surface of a lens, for example, which may  
30 be incorporated into various optical systems, such as AR/VR devices and headsets.

31 **[0035]** An optical element may include a glass substrate and one or more optical layers  
32 disposed over each of the major surfaces of the glass substrate. One or more lamination steps



1 may be used to form such a multilayer stack, and a laser may be used to cut through the stack  
2 and define an optical element having a desired form factor. The optical element may be  
3 affixed to a planar surface of a transparent optical device, such as a lens.

4 **[0036]** A material or element that is “transparent” or “optically transparent” may, for a given  
5 thickness, have a transmissivity within the visible light spectrum of at least approximately  
6 80%, e.g., approximately 80, 90, 95, 97, 98, 99, or 99.5%, including ranges between any of the  
7 foregoing values, and less than approximately 5% bulk haze, e.g., approximately 0.1, 0.2, 0.5,  
8 1, 2, or 5% bulk haze, including ranges between any of the foregoing values. Transparent  
9 materials will typically exhibit very low optical absorption and minimal optical scattering.

10 **[0037]** As used herein, the terms “haze” and “clarity” may refer to an optical phenomenon  
11 associated with the transmission of light through a material, and may be attributed, for  
12 example, to the refraction of light within the material, e.g., due to secondary phases or  
13 porosity and/or the reflection of light from one or more surfaces of the material. As will be  
14 appreciated by those skilled in the art, haze may be associated with an amount of light that is  
15 subject to wide angle scattering (i.e., at an angle greater than 2.5° from normal) and a  
16 corresponding loss of transmissive contrast, whereas clarity may relate to an amount of light  
17 that is subject to narrow angle scattering (i.e., at an angle less than 2.5° from normal) and an  
18 attendant loss of optical sharpness or “see through quality.”

19 **[0038]** A multilayer laminate sheet may include a transparent glass substrate, a first optical  
20 layer assembly disposed over a first surface of the transparent glass substrate, and a second  
21 optical layer assembly disposed over a second surface of the transparent glass substrate  
22 opposite to the first surface. Each optical layer assembly may independently include one or  
23 more optically active layers. As used herein, a “laminate” or a “laminate sheet” may, in some  
24 examples, refer to a composite structure that includes two or more bonded thin films or  
25 layers. In some embodiments, a “glass-film laminate” may include a glass substrate and one  
26 or more optical layers laminated over one or both of the major surfaces of the glass substrate.  
27 In some embodiments, plural optical elements may be harvested from a single laminate  
28 sheet.

29 **[0039]** A glass substrate may be configured to provide mechanical support for an optical  
30 element and may include any suitable organic or inorganic material. For instance, a glass  
31 substrate may include silicon dioxide. By way of example, a silicon dioxide-containing glass  
32 having high light transmittance across the visible spectrum may include, in addition to silicon

1 dioxide (SiO<sub>2</sub>), sodium oxide (Na<sub>2</sub>O) and calcium oxide (CaO), a low amount of iron oxide  
2 coupled with zinc oxide and/or erbium oxide.

3 **[0040]** A glass substrate may have planar and parallel major surfaces. A planar glass substrate  
4 may be regarded as being flat or approximately flat and characterized by opposing major  
5 surfaces each having a surface roughness (R<sub>a</sub>) of less than approximately 1 micrometer, e.g.,  
6 less than approximately 1 micrometer, less than approximately 500 nm, less than  
7 approximately 200 nm, less than approximately 100 nm, less than approximately 50 nm, less  
8 than approximately 20 nm, less than approximately 10 nm, or less than approximately 5 nm,  
9 including ranges between any of the foregoing values.

10 **[0041]** One or more optically active layers may be disposed over each major surface of the  
11 glass substrate. According to some embodiments, each optically active layer may include a  
12 single layer or a multilayer stack of one or more polymer or organic materials, such as  
13 polyvinylidene fluoride (PVDF) or polyethylene (PE), e.g., ultra-high molecular weight  
14 polyethylene (UHMWPE), although additional polymer and organic materials are  
15 contemplated. These and other polymer materials may be crystalline (e.g. single crystal),  
16 partially crystalline, or amorphous (i.e., glassy).

17 **[0042]** The one or more optically active layers may include polarizing thin films, and may  
18 include linear polarizers, circular polarizers, reflective polarizers, transmissive polarizers,  
19 quarter waveplates, half waveplates, and the like.

20 **[0043]** Linear polarizers can be divided into two general categories. In an absorptive  
21 polarizer, unwanted polarization states are absorbed by the optical layer. In a beam-splitting  
22 polarizer, on the other hand, an unpolarized beam of light may be split into two beams with  
23 opposite polarization states.

24 **[0044]** Circular polarizers can be used to create circularly polarized light or, alternatively, to  
25 selectively absorb or pass clockwise and counter-clockwise circularly polarized light.

26 **[0045]** A reflective polarizer may be configured to reflect light of one polarization and  
27 transmit light having the orthogonal polarization. In pancake VR optics and polarization  
28 recycling, for instance, broadband circular reflective polarizers are typically core components  
29 where the reflective polarizer quality may impact the display viewing experience of a user or  
30 the recycling efficiency of the device.

31 **[0046]** Example reflective polarizers include, without limitation, cholesteric reflective  
32 polarizers (CLCs) and/or multilayer birefringent reflective polarizers. In some examples, a

1 reflective polarizer may be fabricated by forming an alignment layer (e.g., a polymer layer or  
2 grating) and forming at least one layer of a cholesteric liquid crystal (CLC) over the alignment  
3 layer that is at least partially aligned to the alignment layer. The alignment layer may include  
4 a photoalignment material (PAM) that may be formed over a substrate. A desired molecular  
5 orientation may be obtained by exposing the PAM to polarized light (such as ultraviolet (UV)  
6 and/or visible light). A CLC may be further processed to stabilize the molecular alignment of  
7 a CLC within a solid material, for example, to provide a chiral material such as a chiral solid. A  
8 CLC may be polymerized, cross-linked, and/or a polymer network may be formed through the  
9 CLC to fix or set the alignment. In some examples, a CLC may be formed using an effective  
10 concentration of a chiral dopant within a nematic liquid crystal, and the chiral nematic  
11 (cholesteric) mixture may further include polymerizable materials.

12 **[0047]** In some examples, a reflective polarizer may include a chiral material, such as a  
13 material having molecular ordering similar to that of a cholesteric liquid crystal, and may  
14 include a solid material derived from cooling, polymerizing, cross-linking, or otherwise  
15 stabilizing the molecular order of a cholesteric liquid crystal. By way of example, a chiral solid  
16 may have a helical optical structure similar to that of a cholesteric liquid crystal, where a  
17 direction of maximum refractive index may describe a helix around a normal to the local  
18 direction of molecular orientation.

19 **[0048]** A reflective polarizer may itself include one or more polymer or organic solid thin film  
20 layers that are stacked to form a multilayer. A multilayer thin film may be formed by clocking  
21 and stacking individual layers. That is, in an example “clocked” multilayer stack, an angle of  
22 refractive index misorientation between successive layers may range from approximately 1°  
23 to approximately 90°, e.g., 1, 2, 5, 10, 20, 30, 40, 45, 50, 60, 70, 80, or 90°, including ranges  
24 between any of the foregoing values.

25 **[0049]** A circular reflective polarizer may include a linear reflective polarizer and quarter  
26 waveplate, where the linear reflective polarizer may be formed from one or more polymer  
27 materials, such as PEN. A circular reflective polarizer can also be made using cholesteric  
28 materials, such as a cholesteric liquid crystal (CLC).

29 **[0050]** A waveplate, or retarder, is an optical device that may be configured to alter  
30 the polarization state of a light wave travelling through it. Two common types of waveplates  
31 are a half-wave plate, which shifts the polarization direction of linearly polarized light, and  
32 a quarter-wave plate, which may convert linearly polarized light into circularly polarized light

1 or vice versa.

2 **[0051]** Within a laminate sheet, i.e., a glass-film laminate, the configuration of one or more  
3 optically active layers, e.g., the orientation between adjacent optically active layers, may be  
4 arranged to provide desired performance or function. For example, a linear polarizer and a  
5 quarter waveplate may be adjacent and mutually oriented within an optical element to  
6 produce circularly polarized light. With the present methods, a desired orientational  
7 relationship between optically active layers may be pre-set at the laminate sheet level for a  
8 plurality of optical elements, obviating the need to orient two or more layers for each  
9 individual optical element, and thus improving angle alignment accuracy.

10 **[0052]** Features from any of the embodiments described herein may be used in combination  
11 with one another in accordance with the general principles described herein. These and other  
12 embodiments, features, and advantages will be more fully understood upon reading the  
13 following detailed description in conjunction with the accompanying drawings and claims.

#### 14 **BRIEF DESCRIPTION OF THE DRAWINGS**

15 **[0053]** The accompanying drawings illustrate a number of examples and are a part of the  
16 specification. Together with the following description, these drawings demonstrate and  
17 explain various principles of the present disclosure.

18 **[0054]** FIG. 1 shows cross-sectional views of (A) a glass-film laminate and (B) a glass-film  
19 laminate including a protective layer disposed over opposing major surfaces.

20 **[0055]** FIG. 2 is a top-down plan view of a glass-film laminate illustrating an optical element  
21 harvest architecture.

22 **[0056]** FIG. 3 illustrates a multi-step laser cutting method for forming an optical element from  
23 a glass-film laminate.

24 **[0057]** FIG. 4 illustrates the formation of an optical element from a glass-film laminate at an  
25 intermediate stage of fabrication.

26 **[0058]** FIG. 5 shows the harvesting of an optical element from a glass-film laminate.

27 **[0059]** FIG. 6 is a cross-sectional schematic view of an optical element integrated with a lens.

28 **[0060]** FIG. 7 is an illustration of exemplary augmented-reality glasses that may be used in  
29 connection with embodiments of this disclosure.

30 **[0061]** FIG. 8 is an illustration of an exemplary virtual-reality headset that may be used in  
31 connection with embodiments of this disclosure.

32 **[0062]** Throughout the drawings, identical reference characters and descriptions indicate

1 similar, but not necessarily identical, elements. While the examples described herein are  
2 susceptible to various modifications and alternative forms, specific examples have been  
3 shown in the drawings and will be described in detail herein. However, the examples  
4 described herein are not intended to be limited to the particular forms disclosed. Rather, the  
5 present disclosure covers all modifications, equivalents, and alternatives falling within the  
6 scope of the appended claims.

7

#### DETAILED DESCRIPTION

8 **[0063]** The following will provide, with reference to FIGS. 1-8, detailed descriptions of  
9 methods for cutting a glass-film laminate (i.e., a laminate sheet) to form an optical element.  
10 The discussion associated with FIGS. 1-6 includes a description of methods of forming a glass-  
11 film laminate and the resulting structure, and laser cutting methods for harvesting plural  
12 optical elements from the laminate that avoid the creation of damage such as ablation and/or  
13 orange peel in the polymer/organic thin film layers and/or cracking or spalling of the glass  
14 substrate. The discussion associated with FIGS. 7 and 8 relates to exemplary virtual reality and  
15 augmented reality devices that may include one or more optical elements as disclosed herein.

16 **[0064]** Referring to FIG. 1, illustrated is a cross-sectional view of a glass-film laminate. Shown  
17 in FIG. 1A, glass-film laminate 100 includes a glass substrate 110, a first optical layer assembly  
18 120 disposed over a first surface of the glass substrate 110, and a second optical layer  
19 assembly 130 disposed over a second surface of the glass substrate 110. First optical layer  
20 assembly 120 may include, for example, a linear polarizer layer 122 laminated to the first  
21 surface of the glass substrate 110, and a quarter waveplate 124 laminated to the linear  
22 polarizer 122. Second optical layer assembly 130 may include a reflective polarizer 132.

23 **[0065]** Referring to FIG. 1B, a protective thin film 140 may be laminated over exposed  
24 surfaces of the first and second optical layer assemblies. During laser cutting, a protective thin  
25 film may decrease the propensity for laser-induced damage to one or more layers within the  
26 laminate. In the various examples disclosed herein, the adhesive layer(s) forming a laminate,  
27 such as glass-film laminate 100, are not illustrated so as to not distract from the principles of  
28 the disclosure.

29 **[0066]** Turning to FIG. 2, shown is a top-down plan view of glass-film laminate 100. Illustrated  
30 are the locations of plural optical elements 200, which are arranged to be defined using a  
31 multi-step laser cutting process and harvested from laminate 100.

32 **[0067]** An example multi-step laser cutting process is illustrated schematically in FIG. 3, where

1 successive laser cutting steps I, II, and III are configured to cut entirely through second optical  
2 layer assembly 130, glass substrate 110, and first optical layer assembly 120, respectively. For  
3 instance, and with reference to FIG. 4, an example process may include laser cutting entirely  
4 through the second optical layer assembly 130 from a second side of the glass substrate 110  
5 to form an optical element pattern 401 in the second optical layer assembly, laser cutting  
6 entirely through the glass substrate 110 from the second side of the glass substrate 110 to  
7 form the optical element pattern 402 in the glass substrate 110, and laser cutting entirely  
8 through the first optical layer assembly 120 from a first side of the glass substrate to form an  
9 optical element 200 having the optical element pattern. FIG. 4 shows laminate 100 following  
10 laser cutting of the second optical layer assembly 130 and the glass substrate 110, and prior  
11 to laser cutting the first optical layer assembly 120. The laser cutting and harvesting of an  
12 optical element 200 from a glass-film laminate 100 is shown in FIG. 5.

13 **[0068]** Referring to FIG. 6, optical element 200 may be disposed over and laminated to a  
14 planar surface of an optical device such as lens 600. In the illustrated example, optical element  
15 200 may be arranged such that the first optical layer assembly 120, including the linear  
16 polarizer layer 122 and the quarter waveplate 124, is located proximate to lens 600.

17 **[0069]** Embodiments of the present disclosure may include or be implemented in conjunction  
18 with various types of artificial-reality systems. Artificial reality is a form of reality that has  
19 been adjusted in some manner before presentation to a user, which may include, for example,  
20 a virtual reality, an augmented reality, a mixed reality, a hybrid reality, or some combination  
21 and/or derivative thereof. Artificial-reality content may include completely computer-  
22 generated content or computer-generated content combined with captured (e.g., real-world)  
23 content. The artificial-reality content may include video, audio, haptic feedback, or some  
24 combination thereof, any of which may be presented in a single channel or in multiple  
25 channels (such as stereo video that produces a three-dimensional (3D) effect to the  
26 viewer). Additionally, in some embodiments, artificial reality may also be associated with  
27 applications, products, accessories, services, or some combination thereof, that are used to,  
28 for example, create content in an artificial reality and/or are otherwise used in (e.g., to  
29 perform activities in) an artificial reality.

30 **[0070]** Artificial-reality systems may be implemented in a variety of different form factors and  
31 configurations. Some artificial-reality systems may be designed to work without near-eye  
32 displays (NEDs). Other artificial-reality systems may include an NED that also provides visibility

1 into the real world (e.g., augmented-reality system 700 in FIG. 7) or that visually immerses a  
2 user in an artificial reality (e.g., virtual-reality system 800 in FIG. 8). While some artificial-  
3 reality devices may be self-contained systems, other artificial-reality devices may  
4 communicate and/or coordinate with external devices to provide an artificial-reality  
5 experience to a user. Examples of such external devices include handheld controllers, mobile  
6 devices, desktop computers, devices worn by a user, devices worn by one or more other  
7 users, and/or any other suitable external system.

8 **[0071]** Turning to FIG. 7, augmented-reality system 700 may include an eyewear device 702  
9 with a frame 710 configured to hold a left display device 715(A) and a right display device  
10 715(B) in front of a user's eyes. Display devices 715(A) and 715(B) may act together or  
11 independently to present an image or series of images to a user. While augmented-reality  
12 system 700 includes two displays, embodiments of this disclosure may be implemented in  
13 augmented-reality systems with a single NED or more than two NEDs.

14 **[0072]** In some examples, augmented-reality system 700 may include one or more sensors,  
15 such as sensor 740. Sensor 740 may generate measurement signals in response to motion of  
16 augmented-reality system 700 and may be located on substantially any portion of frame 710.  
17 Sensor 740 may represent a position sensor, an inertial measurement unit (IMU), a depth  
18 camera assembly, a structured light emitter and/or detector, or any combination thereof. In  
19 some examples, augmented-reality system 700 may or may not include sensor 740 or may  
20 include more than one sensor. In examples in which sensor 740 includes an IMU, the IMU may  
21 generate calibration data based on measurement signals from sensor 740. Examples of sensor  
22 740 may include, without limitation, accelerometers, gyroscopes, magnetometers, other  
23 suitable types of sensors that detect motion, sensors used for error correction of the IMU, or  
24 some combination thereof.

25 **[0073]** Augmented-reality system 700 may also include a microphone array with a plurality  
26 of acoustic transducers 720(A)-720(J), referred to collectively as acoustic transducers 720.  
27 Acoustic transducers 720 may be transducers that detect air pressure variations induced by  
28 sound waves. Each acoustic transducer 720 may be configured to detect sound and convert  
29 the detected sound into an electronic format (e.g., an analog or digital format). The  
30 microphone array in FIG. 7 may include, for example, ten acoustic transducers: 720(A) and  
31 720(B), which may be designed to be placed inside a corresponding ear of the user, acoustic  
32 transducers 720(C), 720(D), 720(E), 720(F), 720(G), and 720(H), which may be positioned at

1 various locations on frame 710, and/or acoustic transducers 720(I) and 720(J), which may be  
2 positioned on a corresponding neckband 705.

3 **[0074]** In some examples, one or more of acoustic transducers 720(A)-(F) may be used as  
4 output transducers (e.g., speakers). For example, acoustic transducers 720(A) and/or 720(B)  
5 may be earbuds or any other suitable type of headphone or speaker.

6 **[0075]** The configuration of acoustic transducers 720 of the microphone array may vary.  
7 While augmented-reality system 700 is shown in FIG. 7 as having ten acoustic transducers  
8 720, the number of acoustic transducers 720 may be greater or less than ten. In some  
9 examples, using higher numbers of acoustic transducers 720 may increase the amount of  
10 audio information collected and/or the sensitivity and accuracy of the audio information. In  
11 contrast, using a lower number of acoustic transducers 720 may decrease the computing  
12 power required by an associated controller 750 to process the collected audio information.  
13 In addition, the position of each acoustic transducer 720 of the microphone array may vary.  
14 For example, the position of an acoustic transducer 720 may include a defined position on the  
15 user, a defined coordinate on frame 710, an orientation associated with each acoustic  
16 transducer 720, or some combination thereof.

17 **[0076]** Acoustic transducers 720(A) and 720(B) may be positioned on different parts of the  
18 user's ear, such as behind the pinna, behind the tragus, and/or within the auricle or fossa. Or,  
19 there may be additional acoustic transducers 720 on or surrounding the ear in addition to  
20 acoustic transducers 720 inside the ear canal. Having an acoustic transducer 720 positioned  
21 next to an ear canal of a user may enable the microphone array to collect information on how  
22 sounds arrive at the ear canal. By positioning at least two of acoustic transducers 720 on  
23 either side of a user's head (e.g., as binaural microphones), augmented-reality device 700 may  
24 simulate binaural hearing and capture a 3D stereo sound field around about a user's head. In  
25 some examples, acoustic transducers 720(A) and 720(B) may be connected to augmented-  
26 reality system 700 via a wired connection 730, and in other examples acoustic transducers  
27 720(A) and 720(B) may be connected to augmented-reality system 700 via a wireless  
28 connection (e.g., a Bluetooth connection). In still other examples, acoustic transducers 720(A)  
29 and 720(B) may not be used at all in conjunction with augmented-reality system 700.

30 **[0077]** Acoustic transducers 720 on frame 710 may be positioned along the length of the  
31 temples, across the bridge, above or below display devices 715(A) and 715(B), or some  
32 combination thereof. Acoustic transducers 720 may be oriented such that the microphone



1 array is able to detect sounds in a wide range of directions surrounding the user wearing the  
2 augmented-reality system 700. In some examples, an optimization process may be performed  
3 during manufacturing of augmented-reality system 700 to determine relative positioning of  
4 each acoustic transducer 720 in the microphone array.

5 **[0078]** In some examples, augmented-reality system 700 may include or be connected to an  
6 external device (e.g., a paired device), such as neckband 705. Neckband 705 generally  
7 represents any type or form of paired device. Thus, the following discussion of neckband 705  
8 may also apply to various other paired devices, such as charging cases, smart watches, smart  
9 phones, wrist bands, other wearable devices, hand-held controllers, tablet computers, laptop  
10 computers, other external compute devices, etc.

11 **[0079]** As shown, neckband 705 may be coupled to eyewear device 702 via one or more  
12 connectors. The connectors may be wired or wireless and may include electrical and/or non-  
13 electrical (e.g., structural) components. In some cases, eyewear device 702 and neckband 705  
14 may operate independently without any wired or wireless connection between them. While  
15 FIG. 7 illustrates the components of eyewear device 702 and neckband 705 in example  
16 locations on eyewear device 702 and neckband 705, the components may be located  
17 elsewhere and/or distributed differently on eyewear device 702 and/or neckband 705. In  
18 some examples, the components of eyewear device 702 and neckband 705 may be located  
19 on one or more additional peripheral devices paired with eyewear device 702, neckband 705,  
20 or some combination thereof.

21 **[0080]** Pairing external devices, such as neckband 705, with augmented-reality eyewear  
22 devices may enable the eyewear devices to achieve the form factor of a pair of glasses while  
23 still providing sufficient battery and computation power for expanded capabilities. Some or  
24 all of the battery power, computational resources, and/or additional features of augmented-  
25 reality system 700 may be provided by a paired device or shared between a paired device and  
26 an eyewear device, thus reducing the weight, heat profile, and form factor of the eyewear  
27 device overall while still retaining desired functionality. For example, neckband 705 may allow  
28 components that would otherwise be included on an eyewear device to be included in  
29 neckband 705 since users may tolerate a heavier weight load on their shoulders than they  
30 would tolerate on their heads. Neckband 705 may also have a larger surface area over which  
31 to diffuse and disperse heat to the ambient environment. Thus, neckband 705 may allow for  
32 greater battery and computation capacity than might otherwise have been possible on a

1 stand-alone eyewear device. Since weight carried in neckband 705 may be less invasive to a  
2 user than weight carried in eyewear device 702, a user may tolerate wearing a lighter eyewear  
3 device and carrying or wearing the paired device for greater lengths of time than a user would  
4 tolerate wearing a heavy standalone eyewear device, thereby enabling users to more fully  
5 incorporate artificial-reality environments into their day-to-day activities.

6 **[0081]** Neckband 705 may be communicatively coupled with eyewear device 702 and/or to  
7 other devices. These other devices may provide certain functions (e.g., tracking, localizing,  
8 depth mapping, processing, storage, etc.) to augmented-reality system 700. In the example  
9 of FIG. 7, neckband 705 may include two acoustic transducers (e.g., 720(I) and 720(J)) that are  
10 part of the microphone array (or potentially form their own microphone subarray). Neckband  
11 705 may also include a controller 725 and a power source 735.

12 **[0082]** Acoustic transducers 720(I) and 720(J) of neckband 705 may be configured to detect  
13 sound and convert the detected sound into an electronic format (analog or digital). In the  
14 example of FIG. 7, acoustic transducers 720(I) and 720(J) may be positioned on neckband 705,  
15 thereby increasing the distance between the neckband acoustic transducers 720(I) and 720(J)  
16 and other acoustic transducers 720 positioned on eyewear device 702. In some cases,  
17 increasing the distance between acoustic transducers 720 of the microphone array may  
18 improve the accuracy of beamforming performed via the microphone array. For example, if a  
19 sound is detected by acoustic transducers 720(C) and 720(D) and the distance between  
20 acoustic transducers 720(C) and 720(D) is greater than, e.g., the distance between acoustic  
21 transducers 720(D) and 720(E), the determined source location of the detected sound may  
22 be more accurate than if the sound had been detected by acoustic transducers 720(D) and  
23 720(E).

24 **[0083]** Controller 725 of neckband 705 may process information generated by the sensors on  
25 neckband 705 and/or augmented-reality system 700. For example, controller 725 may  
26 process information from the microphone array that describes sounds detected by the  
27 microphone array. For each detected sound, controller 725 may perform a direction-of-arrival  
28 (DOA) estimation to estimate a direction from which the detected sound arrived at the  
29 microphone array. As the microphone array detects sounds, controller 725 may populate an  
30 audio data set with the information. In examples in which augmented-reality system 700  
31 includes an inertial measurement unit, controller 725 may compute all inertial and spatial  
32 calculations from the IMU located on eyewear device 702. A connector may convey

1 information between augmented-reality system 700 and neckband 705 and between  
2 augmented-reality system 700 and controller 725. The information may be in the form of  
3 optical data, electrical data, wireless data, or any other transmittable data form. Moving the  
4 processing of information generated by augmented-reality system 700 to neckband 705 may  
5 reduce weight and heat in eyewear device 702, making it more comfortable to the user.

6 **[0084]** Power source 735 in neckband 705 may provide power to eyewear device 702 and/or  
7 to neckband 705. Power source 735 may include, without limitation, lithium ion batteries,  
8 lithium-polymer batteries, primary lithium batteries, alkaline batteries, or any other form of  
9 power storage. In some cases, power source 735 may be a wired power source. Including  
10 power source 735 on neckband 705 instead of on eyewear device 702 may help better  
11 distribute the weight and heat generated by power source 735.

12 **[0085]** As noted, some artificial-reality systems may, instead of blending an artificial reality  
13 with actual reality, substantially replace one or more of a user's sensory perceptions of the  
14 real world with a virtual experience. One example of this type of system is a head-worn display  
15 system, such as virtual-reality system 800 in FIG. 8, that mostly or completely covers a user's  
16 field of view. Virtual-reality system 800 may include a front rigid body 802 and a band 804  
17 shaped to fit around a user's head. Virtual-reality system 800 may also include output audio  
18 transducers 806(A) and 806(B). Furthermore, while not shown in FIG. 8, front rigid body 802  
19 may include one or more electronic elements, including one or more electronic displays, one  
20 or more inertial measurement units (IMUs), one or more tracking emitters or detectors,  
21 and/or any other suitable device or system for creating an artificial reality experience.

22 **[0086]** Artificial-reality systems may include a variety of types of visual feedback mechanisms.  
23 For example, display devices in augmented-reality system 700 and/or virtual-reality system  
24 800 may include one or more liquid crystal displays (LCDs), light emitting diode (LED) displays,  
25 organic LED (OLED) displays, digital light project (DLP) micro-displays, liquid crystal on silicon  
26 (LCoS) micro-displays, and/or any other suitable type of display screen. Artificial-reality  
27 systems may include a single display screen for both eyes or may provide a display screen for  
28 each eye, which may allow for additional flexibility for varifocal adjustments or for correcting  
29 a user's refractive error. Some artificial-reality systems may also include optical subsystems  
30 having one or more lenses (e.g., conventional concave or convex lenses, Fresnel lenses,  
31 adjustable liquid lenses, etc.) through which a user may view a display screen. These optical  
32 subsystems may serve a variety of purposes, including to collimate (e.g., make an object

1 appear at a greater distance than its physical distance), to magnify (e.g., make an object  
2 appear larger than its actual size), and/or to relay (to, e.g., the viewer's eyes) light. These  
3 optical subsystems may be used in a non-pupil-forming architecture (such as a single lens  
4 configuration that directly collimates light but results in so-called pincushion distortion)  
5 and/or a pupil-forming architecture (such as a multi-lens configuration that produces so-  
6 called barrel distortion to nullify pincushion distortion).

7 **[0087]** In addition to or instead of using display screens, some artificial-reality systems may  
8 include one or more projection systems. For example, display devices in augmented-reality  
9 system 700 and/or virtual-reality system 800 may include micro-LED projectors that project  
10 light (using, e.g., a waveguide) into display devices, such as clear combiner lenses that allow  
11 ambient light to pass through. The display devices may refract the projected light toward a  
12 user's pupil and may enable a user to simultaneously view both artificial-reality content and  
13 the real world. The display devices may accomplish this using any of a variety of different  
14 optical components, including waveguide components (e.g., holographic, planar, diffractive,  
15 polarized, and/or reflective waveguide elements), light-manipulation surfaces and elements  
16 (such as diffractive, reflective, and refractive elements and gratings), coupling elements, etc.  
17 Artificial-reality systems may also be configured with any other suitable type or form of image  
18 projection system, such as retinal projectors used in virtual retina displays.

19 **[0088]** Artificial-reality systems may also include various types of computer vision  
20 components and subsystems. For example, augmented-reality system 700 and/or virtual-  
21 reality system 800 may include one or more optical sensors, such as two-dimensional (2D) or  
22 3D cameras, structured light transmitters and detectors, time-of-flight depth sensors, single-  
23 beam or sweeping laser rangefinders, 3D LiDAR sensors, and/or any other suitable type or  
24 form of optical sensor. An artificial-reality system may process data from one or more of these  
25 sensors to identify a location of a user, to map the real world, to provide a user with context  
26 about real-world surroundings, and/or to perform a variety of other functions.

27 **[0089]** Artificial-reality systems may also include one or more input and/or output audio  
28 transducers. In the examples shown in FIG. 8, output audio transducers 806(A) and 806(B)  
29 may include voice coil speakers, ribbon speakers, electrostatic speakers, piezoelectric  
30 speakers, bone conduction transducers, cartilage conduction transducers, tragus-vibration  
31 transducers, and/or any other suitable type or form of audio transducer. Similarly, input audio  
32 transducers may include condenser microphones, dynamic microphones, ribbon

1 microphones, and/or any other type or form of input transducer. In some examples, a single  
2 transducer may be used for both audio input and audio output.

3 **[0090]** While not shown in FIG. 7, artificial-reality systems may include tactile (i.e., haptic)  
4 feedback systems, which may be incorporated into headwear, gloves, body suits, handheld  
5 controllers, environmental devices (e.g., chairs, floormats, etc.), and/or any other type of  
6 device or system. Haptic feedback systems may provide various types of cutaneous feedback,  
7 including vibration, force, traction, texture, and/or temperature. Haptic feedback systems  
8 may also provide various types of kinesthetic feedback, such as motion and compliance.  
9 Haptic feedback may be implemented using motors, piezoelectric actuators, fluidic systems,  
10 and/or a variety of other types of feedback mechanisms. Haptic feedback systems may be  
11 implemented independent of other artificial-reality devices, within other artificial-reality  
12 devices, and/or in conjunction with other artificial-reality devices.

13 **[0091]** By providing haptic sensations, audible content, and/or visual content, artificial-reality  
14 systems may create an entire virtual experience or enhance a user's real-world experience in  
15 a variety of contexts and environments. For instance, artificial-reality systems may assist or  
16 extend a user's perception, memory, or cognition within a particular environment. Some  
17 systems may enhance a user's interactions with other people in the real world or may enable  
18 more immersive interactions with other people in a virtual world. Artificial-reality systems  
19 may also be used for educational purposes (e.g., for teaching or training in schools, hospitals,  
20 government organizations, military organizations, business enterprises, etc.), entertainment  
21 purposes (e.g., for playing video games, listening to music, watching video content, etc.),  
22 and/or for accessibility purposes (e.g., as hearing aids, visual aids, etc.). The embodiments  
23 disclosed herein may enable or enhance a user's artificial-reality experience in one or more  
24 of these contexts and environments and/or in other contexts and environments.

25 **[0092]** The process parameters and sequence of the steps described and/or illustrated herein  
26 are given by way of example only and can be varied as desired. For example, while the steps  
27 illustrated and/or described herein may be shown or discussed in a particular order, these  
28 steps do not necessarily need to be performed in the order illustrated or discussed. The  
29 various exemplary methods described and/or illustrated herein may also omit one or more of  
30 the steps described or illustrated herein or include additional steps in addition to those  
31 disclosed.

32 **[0093]** The preceding description has been provided to enable others skilled in the art to best

1 utilize various aspects of the examples disclosed herein. This exemplary description is not  
2 intended to be exhaustive or to be limited to any precise form disclosed. Many modifications  
3 and variations are possible without departing from the scope of the present disclosure. The  
4 examples disclosed herein should be considered in all respects illustrative and not restrictive.  
5 Reference should be made to the appended claims and their equivalents in determining the  
6 scope of the present disclosure.

7 **[0094]** Unless otherwise noted, the terms “connected to” and “coupled to” (and their  
8 derivatives), as used in the specification and claims, are to be construed as permitting both  
9 direct and indirect (i.e., via other elements or components) connection. In addition, the terms  
10 “a” or “an,” as used in the specification and claims, are to be construed as meaning “at least  
11 one of.” Finally, for ease of use, the terms “including” and “having” (and their derivatives), as  
12 used in the specification and claims, are interchangeable with and have the same meaning as  
13 the word “comprising.”

14 **[0095]** It will be understood that when an element such as a layer or a region is referred to  
15 as being formed on, deposited on, or disposed “on” or “over” another element, it may be  
16 located directly on at least a portion of the other element, or one or more intervening  
17 elements may also be present. In contrast, when an element is referred to as being “directly  
18 on” or “directly over” another element, it may be located on at least a portion of the other  
19 element, with no intervening elements present.

20 **[0096]** As used herein, the term “approximately” in reference to a particular numeric value  
21 or range of values may, in certain embodiments, mean and include the stated value as well  
22 as all values within 10% of the stated value. Thus, by way of example, reference to the numeric  
23 value “50” as “approximately 50” may, in certain embodiments, include values equal to  $50 \pm 5$ ,  
24 i.e., values within the range 45 to 55.

25 **[0097]** As used herein, the term “substantially” in reference to a given parameter, property,  
26 or condition may mean and include to a degree that one of ordinary skill in the art would  
27 understand that the given parameter, property, or condition is met with a small degree of  
28 variance, such as within acceptable manufacturing tolerances. By way of example, depending  
29 on the particular parameter, property, or condition that is substantially met, the parameter,  
30 property, or condition may be at least approximately 90% met, at least approximately 95%  
31 met, or even at least approximately 99% met.

32 **[0098]** While various features, elements or steps of particular embodiments may be disclosed

1 using the transitional phrase “comprising,” it is to be understood that alternative  
2 embodiments, including those that may be described using the transitional phrases  
3 “consisting” or “consisting essentially of,” are implied. Thus, for example, implied alternative  
4 embodiments to a glass substrate that comprises or includes silicon dioxide include  
5 embodiments where a glass substrate consists essentially of silicon dioxide and embodiments  
6 where a glass substrate consists of silicon dioxide.

1    **CLAIMS**

- 2       1.    A method comprising:
- 3           forming a first optical layer assembly over a first surface of a planar glass substrate;
- 4           forming a second optical layer assembly over a second surface of the planar glass
- 5    substrate;
- 6           laser cutting entirely through the first optical layer assembly from a first side of the
- 7    planar glass substrate to form an optical element pattern in the first optical layer assembly;
- 8           laser cutting entirely through the planar glass substrate from the first side of the
- 9    planar glass substrate to form the optical element pattern in the planar glass substrate; and
- 10          laser cutting entirely through the second optical layer assembly from a second side
- 11   of the planar glass substrate to form an optical element having the optical element pattern.
- 12       2.    The method of claim 1, wherein the planar glass substrate is optically transparent.
- 13       3.    The method of claim 1 or 2, wherein the first optical layer assembly comprises one
- 14   or more optical layers selected from the group consisting of a linear polarizer, a circular
- 15   polarizer, a reflective polarizer, a transmissive polarizer, a quarter waveplate, and a half
- 16   waveplate;
- 17          preferably wherein the second optical layer assembly comprises one or more optical
- 18   layers selected from the group consisting of a linear polarizer, a circular polarizer, a reflective
- 19   polarizer, a transmissive polarizer, a quarter waveplate, and a half waveplate.
- 20       4.    The method of claim 3, wherein the first optical layer assembly comprises a linear
- 21   polarizer and a quarter waveplate, and the second optical layer assembly comprises a
- 22   reflective polarizer.
- 23       5.    The method of any preceding claim, wherein forming the first optical layer assembly
- 24   comprises laminating one or more first optical layers over the first surface of the planar glass
- 25   substrate, and forming the second optical layer assembly comprises laminating one or more
- 26   second optical layers over the second surface of the planar glass substrate.
- 27       6.    The method of any preceding claim, further comprising forming a first protective
- 28   thin film over the first optical layer assembly prior to laser cutting the first optical layer
- 29   assembly, and forming a second protective thin film over the second optical layer assembly
- 30   prior to laser cutting the second optical layer assembly.
- 31       7.    The method of any preceding claim, wherein laser cutting the first optical layer
- 32   assembly comprises first laser parameters, laser cutting the second optical layer assembly



1 comprises second laser parameters, and laser cutting the planar glass substrate comprises  
2 laser parameters different than the first and second laser parameters;  
3 preferably wherein a laser power for laser cutting the planar glass substrate is greater than a  
4 laser power for laser cutting either the first optical layer assembly or the second optical layer  
5 assembly.

6 8. The method of any preceding claim, wherein:  
7 forming the first optical layer assembly over the first surface of the planar glass  
8 substrate and forming the second optical layer assembly over the second surface of the planar  
9 glass substrate create a laminate sheet; and  
10 a plurality of optical elements having the optical element pattern are cut from the  
11 laminate sheet.

12 9. The method of any of any preceding claim, further comprising forming the optical  
13 element over a planar surface of a lens, the optical element comprising, from top to bottom,  
14 a reflective polarizer, the planar glass substrate, a linear polarizer, and a quarter waveplate,  
15 wherein the quarter waveplate is located adjacent to the planar surface of the lens;  
16 preferably wherein the lens has the optical element pattern.

17 10. A method comprising:  
18 forming an optical element pattern in a first optical layer assembly disposed over a  
19 first surface of a planar glass substrate by laser cutting entirely through the first optical layer  
20 assembly from a first side of the planar glass substrate;  
21 forming the optical element pattern in the planar glass substrate by laser cutting  
22 entirely through the planar glass substrate from the first side of the planar glass substrate;  
23 and  
24 forming an optical element having the optical element pattern by laser cutting  
25 entirely through a second optical layer assembly from a second side of the planar glass  
26 substrate, the second optical layer assembly disposed over a second surface of the planar  
27 glass substrate.

28 11. The method of claim 10, wherein the planar glass substrate is optically transparent;  
29 preferably wherein a laser power for laser cutting the planar glass substrate is different than  
30 a laser power for laser cutting either the first optical layer assembly or the second optical  
31 layer assembly

32 12. The method of claim 10 or 11, wherein the first optical layer assembly comprises

1 one or more optical layers selected from the group consisting of a linear polarizer, a circular  
2 polarizer, a reflective polarizer, a transmissive polarizer, a quarter waveplate, and a half  
3 waveplate;

4 preferably wherein the second optical layer assembly comprises one or more optical  
5 layers selected from the group consisting of a linear polarizer, a circular polarizer, a reflective  
6 polarizer, a transmissive polarizer, a quarter waveplate, and a half waveplate.

7 13. The method of claim 12, wherein the first optical layer assembly comprises a linear  
8 polarizer and a quarter waveplate, and the second optical layer assembly comprises a  
9 reflective polarizer.

10 14. A method comprising:

11 laminating a first optical layer assembly over a first surface of a transparent planar  
12 glass substrate;

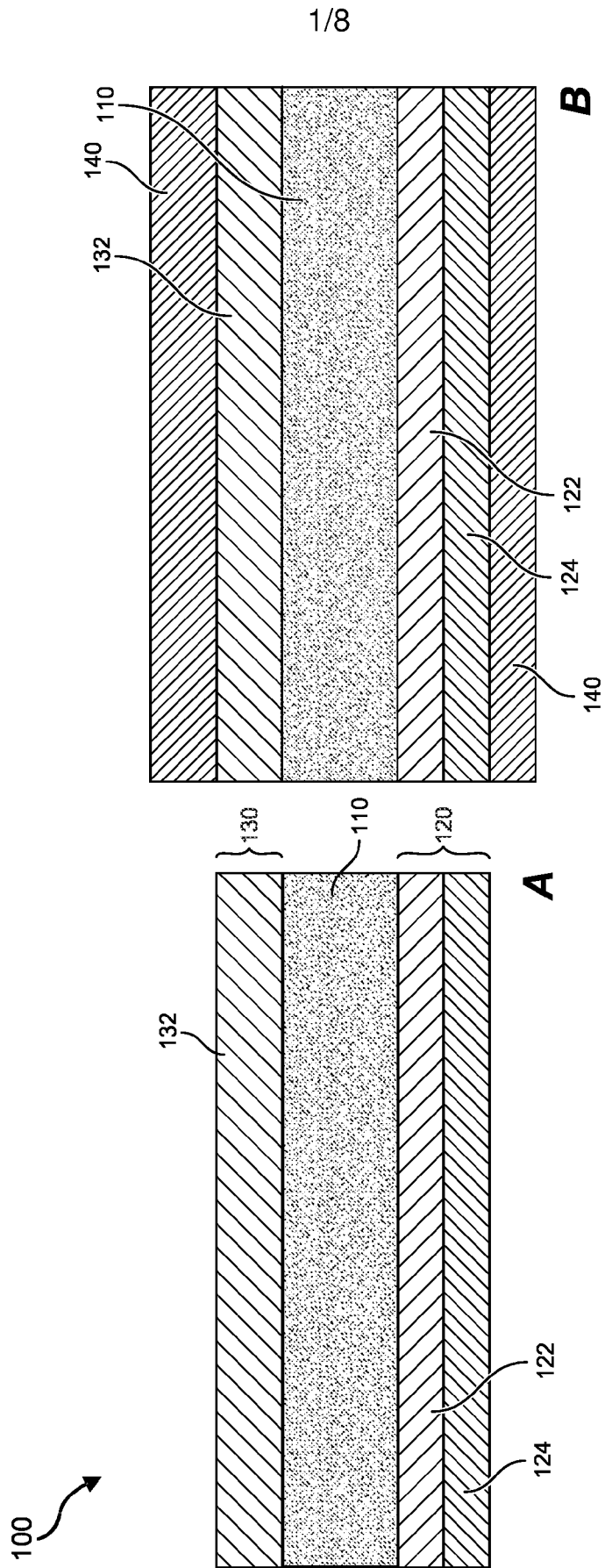
13 laminating a second optical layer assembly over a second surface of the transparent  
14 planar glass substrate;

15 laser cutting through the first optical layer assembly from a first side of the  
16 transparent planar glass substrate to form an optical element pattern in the first optical layer  
17 assembly;

18 laser cutting through the transparent planar glass substrate from the first side of the  
19 transparent planar glass substrate to form the optical element pattern in the transparent  
20 planar glass substrate; and

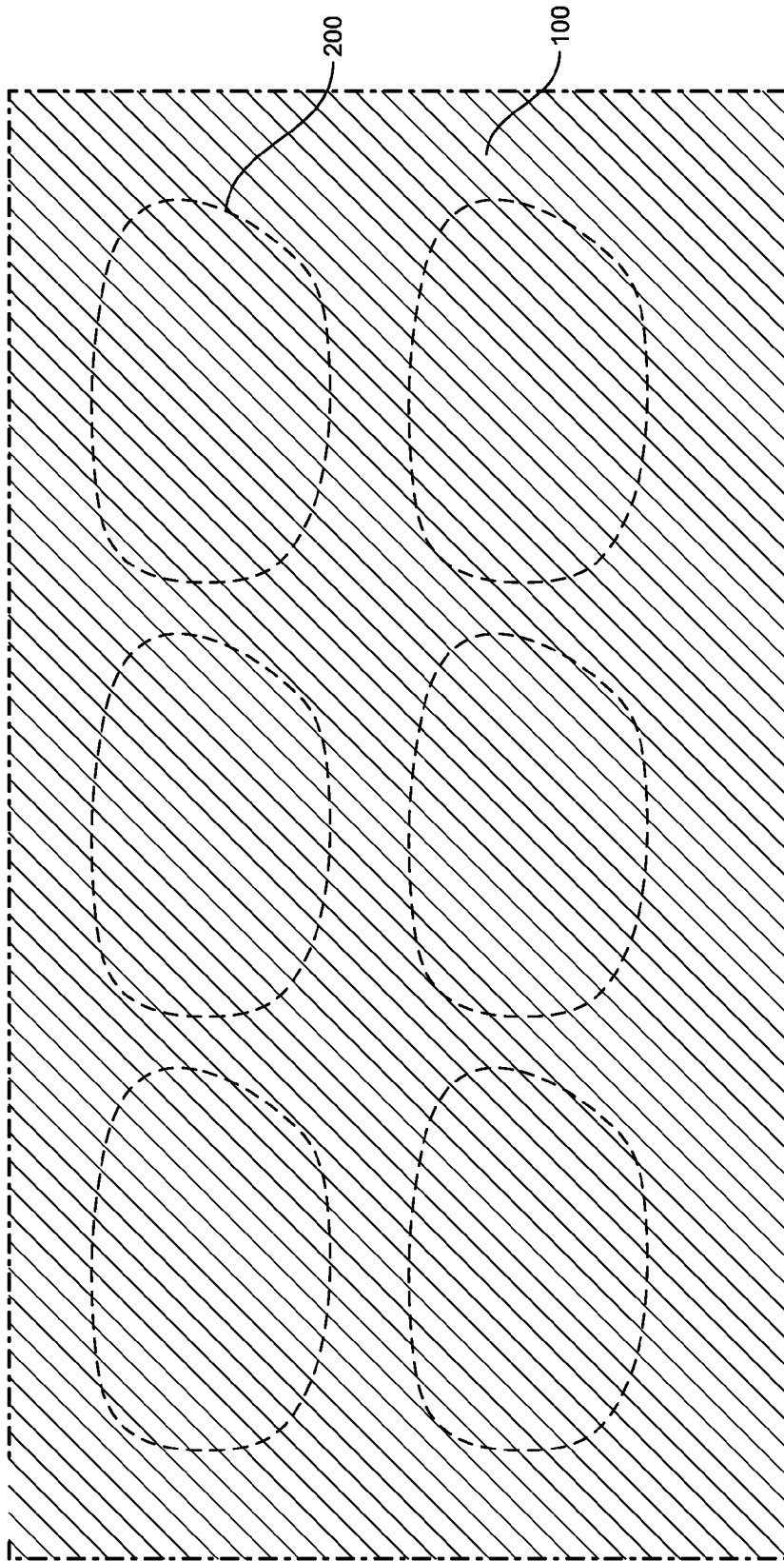
21 laser cutting through the second optical layer assembly from a second side of the  
22 transparent planar glass substrate to form an optical element having the optical element  
23 pattern.

24 15. The method of claim 14, further comprising forming a first protective thin film over  
25 the first optical layer assembly prior to laser cutting the first optical layer assembly, and  
26 forming a second protective thin film over the second optical layer assembly prior to laser  
27 cutting the second optical layer assembly.

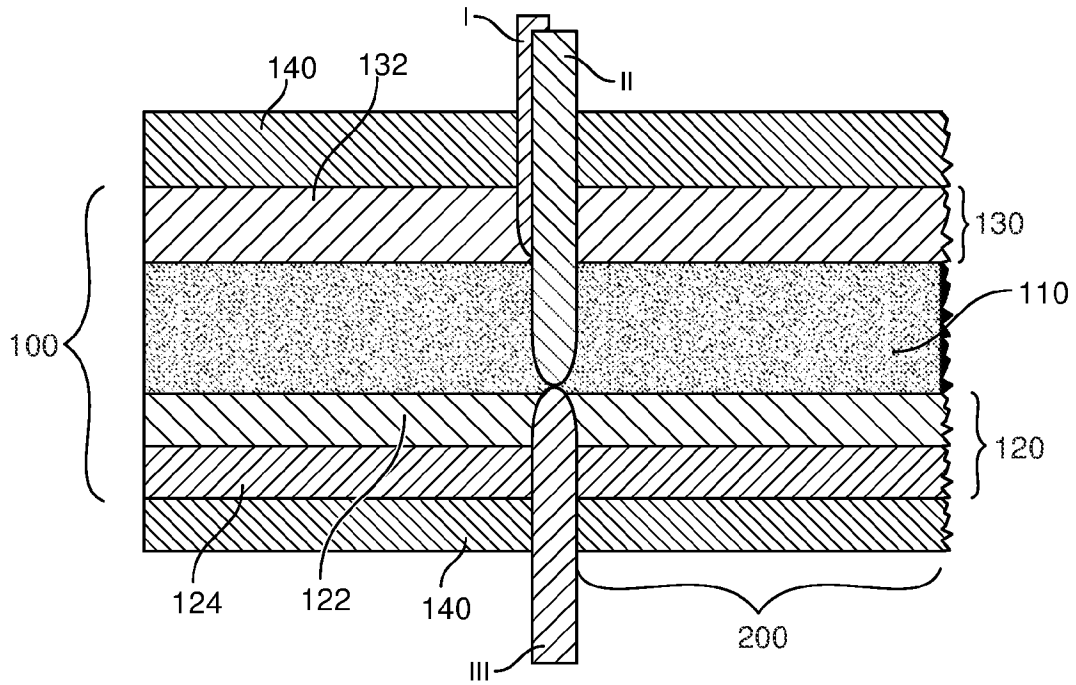


**FIG. 1**

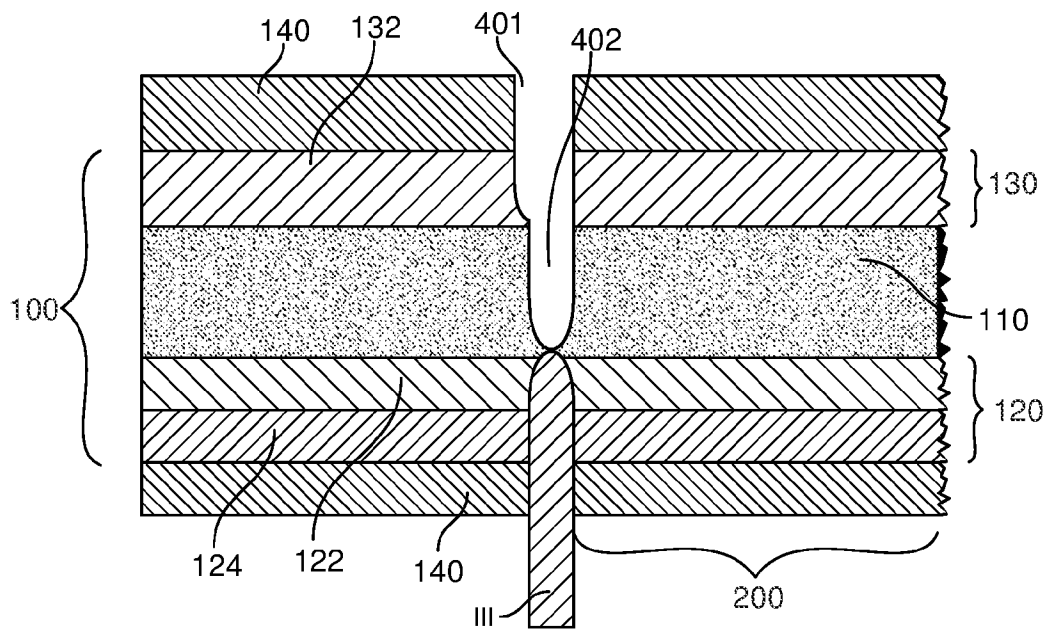
2/8



**FIG. 2**

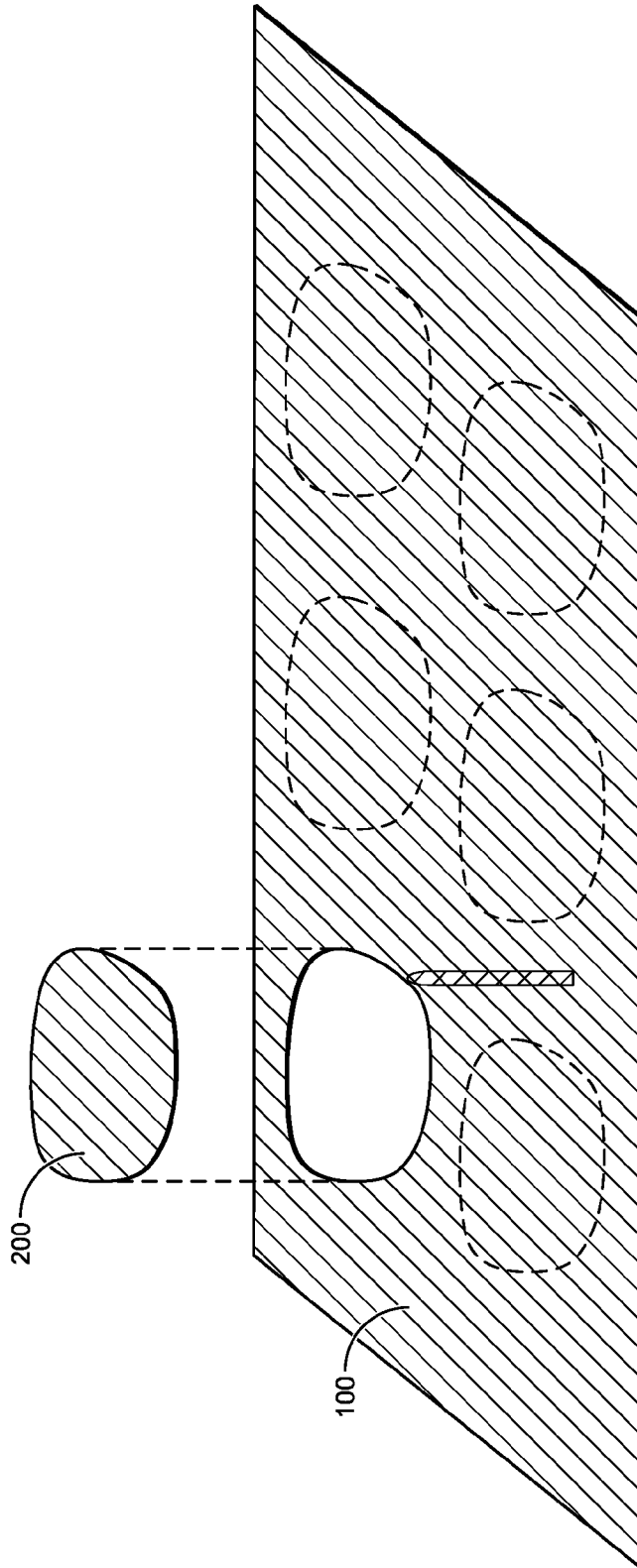


**FIG. 3**

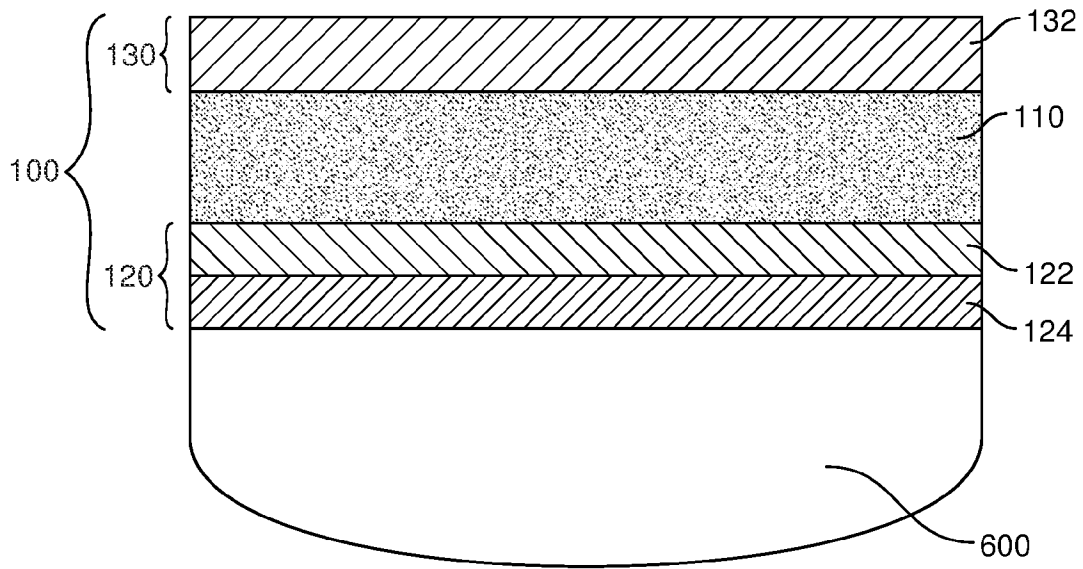


**FIG. 4**

5/8

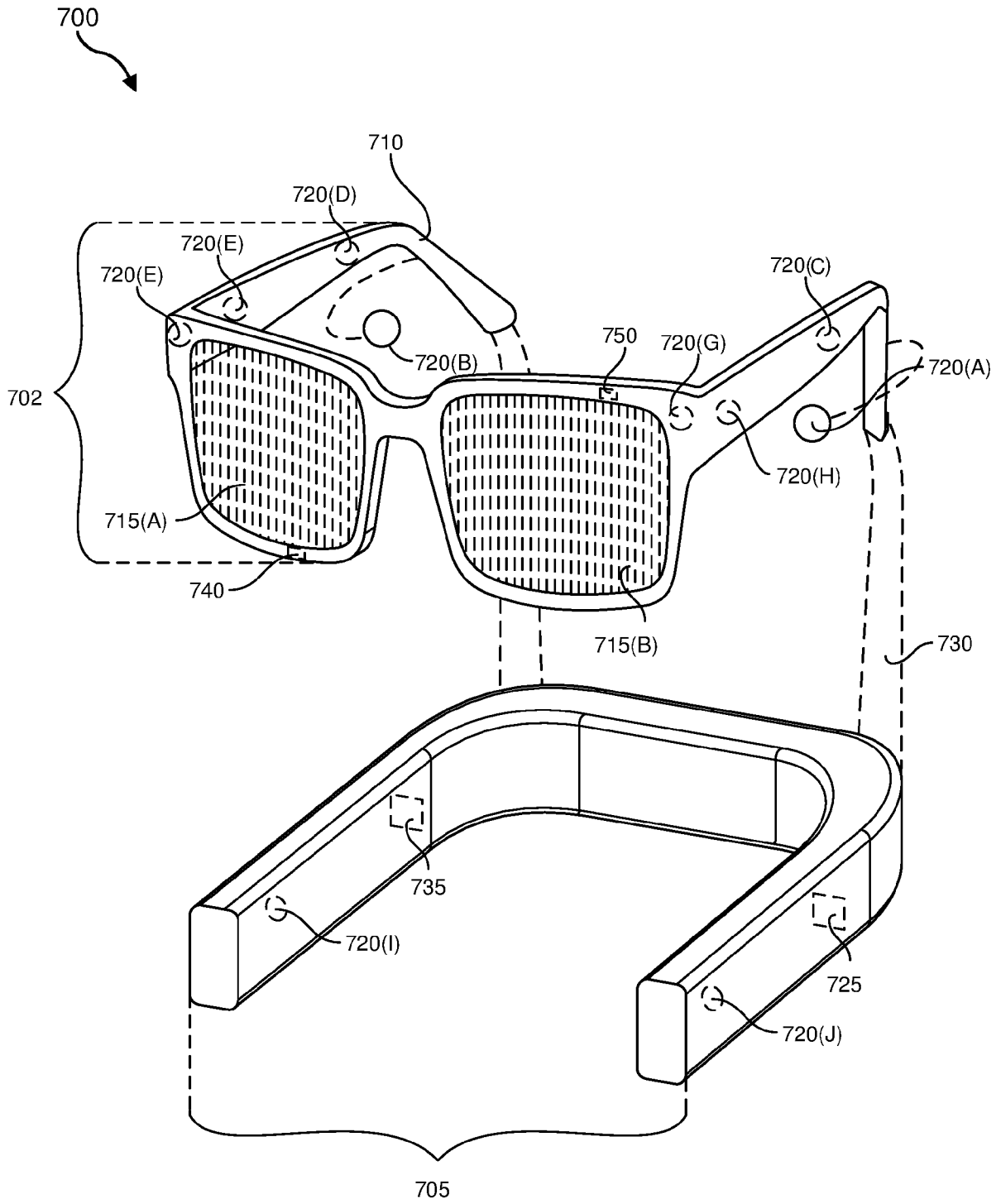


**FIG. 5**

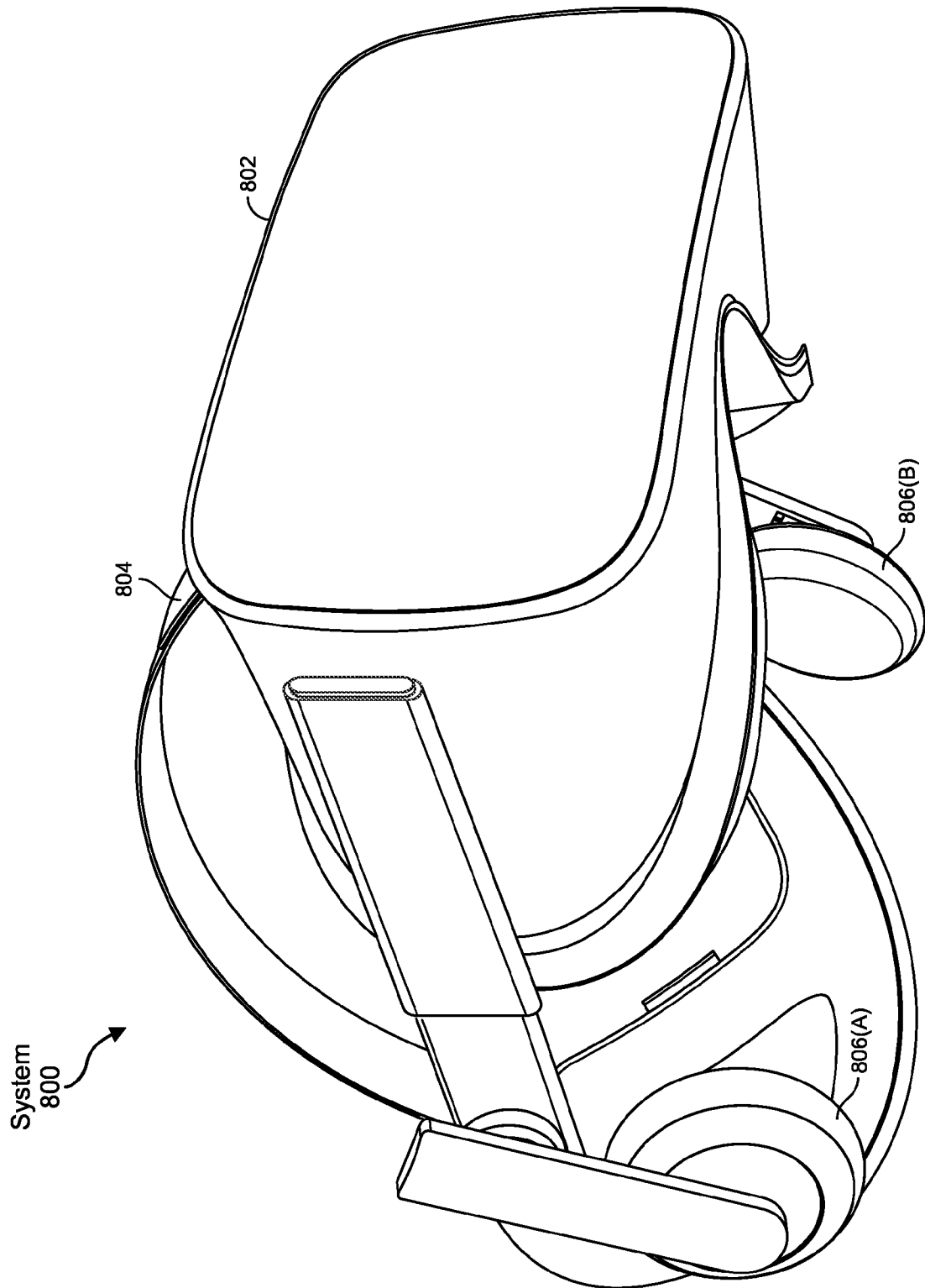


**FIG. 6**





**FIG. 7**



**FIG. 8**

# INTERNATIONAL SEARCH REPORT

International application No  
**PCT/US2023/019518**

**A. CLASSIFICATION OF SUBJECT MATTER**  
**INV.**    **B23K26/00**            **B23K26/06**            **B23K26/364**            **B23K26/38**            **B23K26/402**  
              **C03B33/02**            **C03B33/07**            **B32B17/06**  
**ADD.**    **G02B5/30**            **G02B27/01**  
According to International Patent Classification (IPC) or to both national classification and IPC

**B. FIELDS SEARCHED**  
Minimum documentation searched (classification system followed by classification symbols)  
**B23K C03B G02B**

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)  
**EPO-Internal, WPI Data**

**C. DOCUMENTS CONSIDERED TO BE RELEVANT**

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
<b>X</b>	<b>WO 2021/181766 A1 (NITTO DENKO CORP [JP])</b> <b>16 September 2021 (2021-09-16)</b> <b>paragraphs [0035], [0042], [0047],</b> <b>[0048], [0055], [0061], [0084], [0085]</b> <b>figures 2a-2d, 4</b> -----	<b>1-15</b>
<b>X</b>	<b>JP 2014 043363 A (HAMAMATSU PHOTONICS KK)</b> <b>13 March 2014 (2014-03-13)</b> <b>paragraphs [0008], [0024], [0025]</b> <b>figures 4, 5</b> -----	<b>1, 10, 14</b>
<b>A</b>	<b>US 2022/080529 A1 (SNAP INC [US])</b> <b>17 March 2022 (2022-03-17)</b> <b>paragraphs [0011], [0019]</b> <b>figures 1-5</b> -----	<b>1, 10, 14</b>
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Further documents are listed in the continuation of Box C.                       See patent family annex.

\* Special categories of cited documents :

<p>"A" document defining the general state of the art which is not considered to be of particular relevance</p> <p>"E" earlier application or patent but published on or after the international filing date</p> <p>"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)</p> <p>"O" document referring to an oral disclosure, use, exhibition or other means</p> <p>"P" document published prior to the international filing date but later than the priority date claimed</p>	<p>"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone</p> <p>"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art</p> <p>"&amp;" document member of the same patent family</p>
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Date of the actual completion of the international search	Date of mailing of the international search report
<b>2 August 2023</b>	<b>14/08/2023</b>

Name and mailing address of the ISA/ European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Fax: (+31-70) 340-3016	Authorized officer  <b>Hillmayr, Heinrich</b>
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# INTERNATIONAL SEARCH REPORT

International application No  
PCT/US2023/019518

C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
<b>A</b>	<b>WO 2021/100201 A1 (MITSUBISHI HEAVY IND LTD [JP]) 27 May 2021 (2021-05-27) paragraphs [0069] - [0071] figure 12</b>  -----	<b>1, 10, 14</b>

# INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No <b>PCT/US2023/019518</b>
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Patent document cited in search report	Publication date	Patent family member(s)	Publication date
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		<b>JP WO2021181766 A1</b>	<b>16-09-2021</b>
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		<b>WO 2021181766 A1</b>	<b>16-09-2021</b>
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<b>JP 2014043363 A</b>	<b>13-03-2014</b>	<b>NONE</b>	
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		<b>EP 4211085 A1</b>	<b>19-07-2023</b>
		<b>KR 20230068419 A</b>	<b>17-05-2023</b>
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		<b>WO 2022055724 A1</b>	<b>17-03-2022</b>
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<b>WO 2021100201 A1</b>	<b>27-05-2021</b>	<b>EP 4046742 A1</b>	<b>24-08-2022</b>
		<b>US 2022410319 A1</b>	<b>29-12-2022</b>
		<b>WO 2021100201 A1</b>	<b>27-05-2021</b>
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